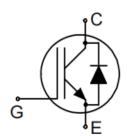


FGH75T65SHD-VB Datasheet 650 V Trench and Fieldstop IGBT

PRODUCT SUMM	ARY
V _{CE} (V)	650
I _C (A)	90 (TC=25) 75 (TC=100)
VCE (sat) (V)	1.8
Q _g (nC)	175
Ісм (А)	225



TO-247



Top View

FEATURES

- Very Low VCEsat
- · Low turn-off losses
- High speed switching
- Maximum junction temperature 175°C
- Ultra low gate charge (Qg)
- Avalanche energy rated (UIS)

RoHS COMPLIANT HALOGEN FREE

APPLICATIONS

- Telecommunications
 - Server and telecom power supplies
- Lighting
 - High-intensity discharge (HID)
 - Fluorescent ballast lighting
- Consumer and computing
 - ATX power supplies
- Industrial
 - Welding
 - Battery chargers
- Renewable energy
 - Solar (PV inverters)
- Switch mode power supplies (SMPS)

Package pin definition

- Pin1 G Gate
- Pin2 C & backside Collector
- Pin3 E Emitter

ABSOLUTE MAXIMUM RATINGS (T_C	= 25 °C, unl	ess otherwis	se noted)		
PARAMETER			SYMBOL	LIMIT	UNIT
Collector-Emitter Voltage			V_{CE}	650	V
Gate-Emitter Voltage			V_{GE}	±30	7 v
Continuous Collector Current (T _{.I} = 150 °C)	\/ ot 15 \/	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$		90	
Continuous Collector Current (1 _J = 150 °C)	V _{GE} at 15 V	T _C = 100 °C	I _C	75	Α
Pulsed Collector Current ^a			I _{CM}	225	
Diode Forward Current ^b			I _F	90	А
Maximum Power Dissipation		T _C = 25 °C	P _D	400	W
Waximum Tower Dissipation		T _C = 100 °C	. Б	220	W
Operating Junction and Storage Temperature Range	е		T _J , T _{stg}	-55 to +175	°C
Short Circuit Withstand Time TC=150	VGE= 15V, VCE 400V		3	3	
Short Circuit Withstand Time TC=100	VGE= 15V, V	CE 330V	tsc	5	μs
Soldering Recommendations (Peak Temperature) c	for	10 s		260	°C

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. Current limited by maximum junction temperature.
- c. 1.6 mm from case.

服务热线:400-655-8788

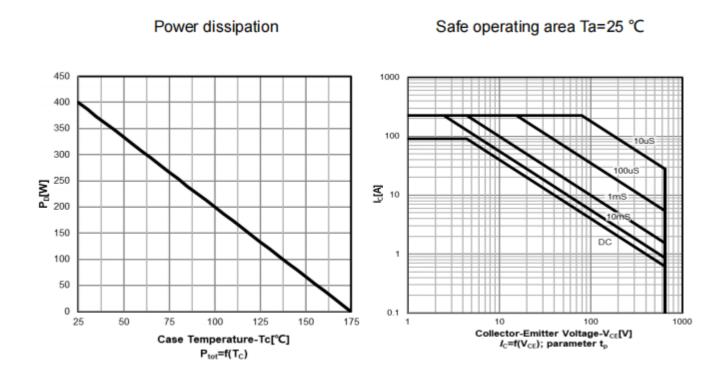


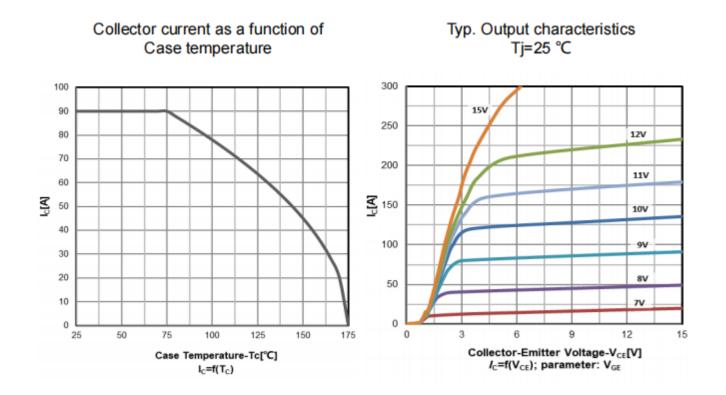
THERMAL RESISTANCE RATI	NGS			
PARAMETER	SYMBOL	TYP.	MAX.	UNIT
Maximum Junction-to-Ambient	R _{thJA}	-	40	°C/W
Maximum Junction-to-Case	R _{thJC}	-	0.5	C/ VV

PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNIT
Static							<u> </u>
	D) /	V _{GE} :	= 0 V, I _C = 250 μA	650	-	-	.,
Collector-Emitter Breakdown Voltage	BV _{CE}	VGE	= 0 V, Ic = 1 mA	650	-	-	V
Gate-Source Threshold Voltage (N)	V _{GE(th)}	V _{CE} =	= V _{GE} , I _D = 250 μA	4	5	6	V
Zova Cata Valtaga Callantay Cuyyant		V _{CE} = 650 V,	VGE = 0 V,TJ = 25 °C	-	1	20	μA
Zero Gate Voltage Collector Current	I _{CES}	VCE = 650 V,	VGE = 0 V,TJ = 150 °C	-	1000	-	μΑ
Gate-Emitter Leakage Current	I _{GES}	V _{CE} = 0	V , $V_{GS} = \pm 2 0 V$	-	-	100	nA
Collector-Emitter Saturation Voltage	V _{CE(sat)}	V _{GE} = 15 V	I _C = 75 A	-	1.8	2.1	V
Forward Transconductance	9 _{fs}	V _{CE}	= 20 V, I _C = 75 A	-	40	-	S
Dynamic				•			•
Input Capacitance	C _{ies}	Vo-	= 0 V, Vce = 25 V,	-	4500	-	
Output Capacitance	Coes	▼ GE	f = 500 KHz	-	235	-	pF
Reverse Transfer Capacitance	C _{res}		- f = 500 KHZ		72	-	1
Turn-on Energy	E _{on}	V _{CE} = 40	$V_{CE} = 400 \text{ V}$, $V_{GE} = 0 / 15 \text{V}$,		0.62	-	ns
Turn-off Energy	Eoff	$I_C = 75 \text{ A}, R_g = 10\Omega$		-	0.31	-	113
Total Gate Charge	Qg			-	175	-	
Gate-Emitter Charge	Q_{ge}	V _{GE} = 15 V	$I_C = 75 \text{ A}, V_{CE} = 400 \text{ V}$	-	14	-	nC
Gate to Collector Charge	Q_{gc}			-	33	-	
Turn-On Delay Time	t _{d(on)}	$V_{CE} = 400 \text{ V}$, $V_{GE} = 0 / 15 \text{ V}$,		-	60	-	
Rise Time	t _r	V CE	$= 400 \text{ V}, \text{ V}_{GE} = 0 / 15 \text{ V},$	-	43	-	ns
Turn-Off Delay Time	t _{d(off)}	$I_{C} = 75 \text{ A}, R_{q} = 10\Omega$		-	184	-	113
Fall Time	t _f			-	30	-	
Internal emitter inductance measured 5 mm	L _E			-	13	-	nH
Diode Characteristics		_		•	_	_	1
Diode Forward Current	I _F	IGBT symbol showing the integral reverse junction diode		-	-	90	A
Pulsed Diode Forward Current	I _{FM}	integralite	voice junction diode	-	-	225	
Diode Forward Voltage	V _F		I _F = 30 A	-	1.65	2.0	V
Reverse Recovery Time	t _{rr}			-	73	-	ns
Reverse Recovery Charge	Q _{rr}	$T_J = 25 ^{\circ}\text{C}, I_F = 30 \text{A},$		-	80	-	μC
Reverse Recovery Current	I _{RRM}	dlf/dt = 200 A/ μ s, V _R = 400 V		-	13	-	Α



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)





服务热线:400-655-8788



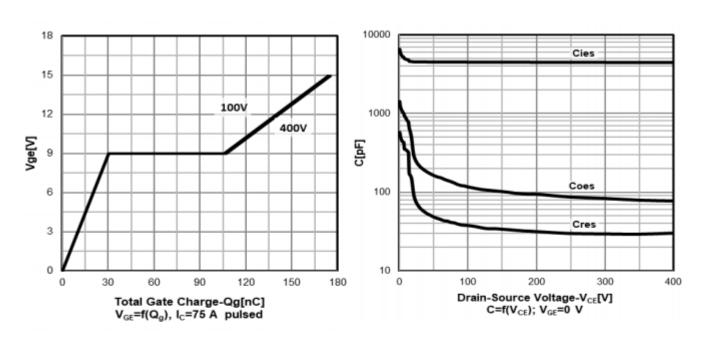
Typ. Output characteristics Typ. Transfer characteristics Tj=150 ℃ 300 300 15V 250 250 12V 200 200 Tj=25°C 11V **2** 150 **₹** 150 Tj=150°C 10V 100 100 8V 50 50 7V 0 0 15 12 14 Collector-Emitter Voltage- $V_{CE}[V]$ Gate-Emitter Voltage-V_{GE}[V] $I_C=f(V_{CE})$; parameter: V_{GE} $I_C=f(V_{GE}); V_{CE}=20V$

Typ. Collector-emitter saturation Normalized V_{GE(th)} vs. temperature voltage as a function of junction temperature (VGE=15V) 3.4 1.4 3 1.2 2.6 100A Normalized Vth 2.2 Acesat[V] 75A 504 1.4 0.6 0.6 25 -20 75 100 125 175 -60 Junction Temperature-Tj[°C] Junction Temperature-Tj[°C] $V_{GE(th)}=f(T_j);$ $V_{CE(SAT)}=f(T_j)$; parameter: I_C

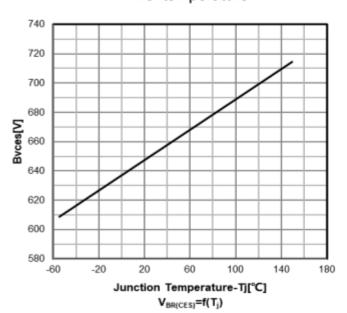


Gate charge characteristics

Capacitance characteristics



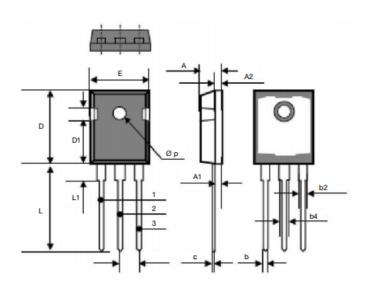
Collector-emitter breakdown voltage vs. temperature



服务热线:400-655-8788 5



TO-247



DIM.	MILLIN	METERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
Α	4.70	5.31	0.185	0.209	
A1	2.21	2.59	0.087	0.102	
A2	1.50	2.49	0.059	0.098	
b	0.99	1.40	0.039	0.055	
b2	1.65	2.41	0.065	0.095	
b4	2.59	3.43	0.102	0.135	
С	0.61 BSC		0.024 BSC		
D	20.80	21.46	0.819	0.845	
D1	3.68	5.49	0.145	0.216	
(e)	5.46 BSC		0.215 BSC		
E	15.49	16.26	0.610	0.640	
L	19.81	20.32	0.780	0.800	
L1	4.06	4.50	0.160	0.177	
Ø p	3.51	3.66	0.138	0.144	



Disclaimer

All products due to improve reliability, function or design or for other reasons, product specifications and data are subject to change without notice.

Taiwan VBsemi Electronics Co., Ltd., branches, agents, employees, and all persons acting on its or their representatives (collectively, the "Taiwan VBsemi"), assumes no responsibility for any errors, inaccuracies or incomplete data contained in the table or any other any disclosure of any information related to the product.(www.VBsemi.com)

Taiwan VBsemi makes no guarantee, representation or warranty on the product for any particular purpose of any goods or continuous production. To the maximum extent permitted by applicable law on Taiwan VBsemi relinquished: (1) any application and all liability arising out of or use of any products; (2) any and all liability, including but not limited to special, consequential damages or incidental; (3) any and all implied warranties, including a particular purpose, non-infringement and merchantability guarantee.

Statement on certain types of applications are based on knowledge of the product is often used in a typical application of the general product VBsemi Taiwan demand that the Taiwan VBsemi of. Statement on whether the product is suitable for a particular application is non-binding. It is the customer's responsibility to verify specific product features in the products described in the specification is appropriate for use in a particular application. Parameter data sheets and technical specifications can be provided may vary depending on the application and performance over time. All operating parameters, including typical parameters must be made by customer's technical experts validated for each customer application. Product specifications do not expand or modify Taiwan VBsemi purchasing terms and conditions, including but not limited to warranty herein.

Unless expressly stated in writing, Taiwan VBsemi products are not intended for use in medical, life saving, or life sustaining applications or any other application. Wherein VBsemi product failure could lead to personal injury or death, use or sale of products used in Taiwan VBsemi such applications using client did not express their own risk. Contact your authorized Taiwan VBsemi people who are related to product design applications and other terms and conditions in writing.

The information provided in this document and the company's products without a license, express or implied, by estoppel or otherwise, to any intellectual property rights granted to the VBsemi act or document. Product names and trademarks referred to herein are trademarks of their respective representatives will be all.

Material Category Policy

Taiwan VBsemi Electronics Co., Ltd., hereby certify that all of the products are determined to be RoHS compliant and meets the definition of restrictions under Directive of the European Parliament 2011/65 / EU, 2011 Nian. 6. 8 Ri Yue restrict the use of certain hazardous substances in electrical and electronic equipment (EEE) - modification, unless otherwise specified as inconsistent.(www.VBsemi.com)

Please note that some documents may still refer to Taiwan VBsemi RoHS Directive 2002/95 / EC. We confirm that all products identified as consistent with the Directive 2002/95 / EC European Directive 2011/65 /.

Taiwan VBsemi Electronics Co., Ltd. hereby certify that all of its products comply identified as halogen-free halogen-free standards required by the JEDEC JS709A. Please note that some Taiwanese VBsemi documents still refer to the definition of IEC 61249-2-21, and we are sure that all products conform to confirm compliance with IEC 61249-2-21 standard level JS709A.